



# Through Hole Lamp Product Data Sheet LTW-404M01H279

Spec No. :DS20-2019-0044  
Effective Date: 11/25/2020  
Revision: A

**LITE-ON DCC**

**RELEASE**

BNS-OD-FC001/A4

## Through Hole Lamp LTW-404M01H279

### Through Hole Lamp

LTW-404M01H279

<u>Rev</u>	<u>Description</u>	<u>By</u>	<u>Date</u>
P01	Preliminary Specification (RDR-20181615-01)	Javy H.	12/05/2018
P02	Update spec to meet customer application	Javy H.	04/19/2019
P03	Update Packing Specification	Javy H.	05/21/2019
P04	Update Bin Table Specification	Javy H.	06/06/2019
P05	Chromaticity Coordinates Correction (White color), Add Inch Unit to Drawing	Javy H.	06/10/2019
<b>Above data for PD and Customer tracking only</b>			
-	New Specification Upload On OPNC	Chalerm Ya.	07/04/2019
A	Add Protruded LED Specification: 0.20±0.14 mm	Javy H.	11/11/2020

# Through Hole Lamp LTW-404M01H279

## 1. Description

CBI (Circuit Board Indicator) is a black plastic right angle Holder (Housing) which mates with Lite-On LED lamps. Lite-On CBI is available in a wide variety of packages, including top-view (Spacer) or right angle and horizontal or vertical arrays which is stackable and easy to assembly.

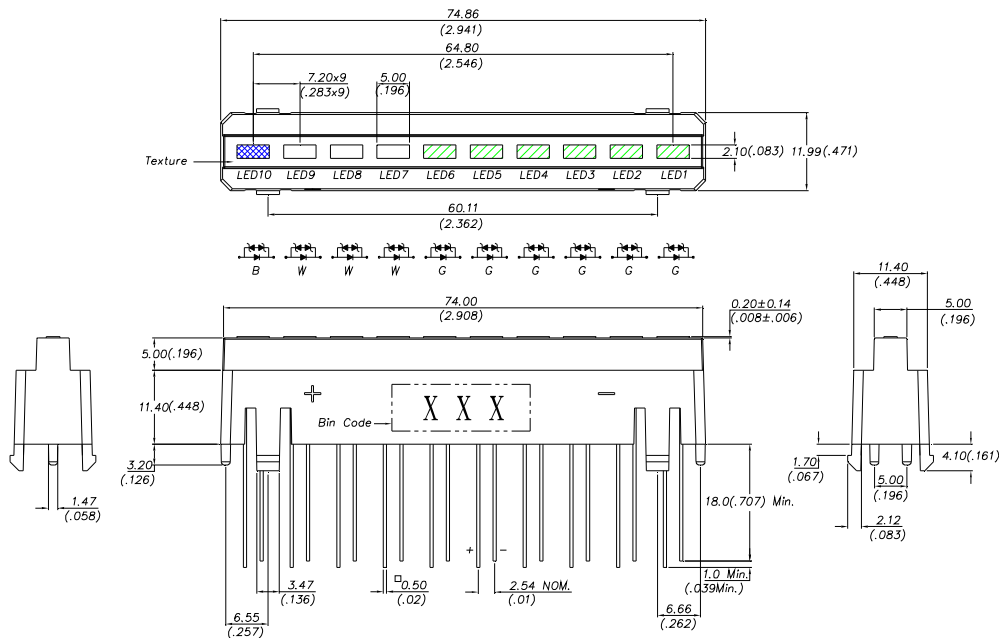
### 1.1. Features

- Designed for ease in circuit board assembly
- Black case enhance contrast ratio
- Solid state light source
- Lead free product & RoHS Compliant
- InGaN Blue/White, Green chips and Zener diode
- ESD protected

### 1.2. Applications

- Communication
- Computer
- Consumer
- Industrial

## 2. Outline Dimensions



### Notes :

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25\text{mm}$  (.010") unless otherwise noted.
3. The Holder (Housing) material is plastic / black.
4. LED1~6 are green color and green diffused lens; LED7~9 are white color and white diffused lens; LED10 is blue color and blue diffused lens.
5. Specifications are subject to change without notice.

## Through Hole Lamp LTW-404M01H279

### 3. Absolute Maximum Ratings at TA=25°C

Parameter	White	Blue	Green	Unit
Power Dissipation	102	74	64	mW
Peak Forward Current (Duty Cycle $\leq 1/10$ , Pulse Width $\leq 10\text{ms}$ )	100	100	60	mA
DC Forward Current	30	20	20	mA
Operating Temperature Range	-30°C to + 85°C			
Storage Temperature Range	-40°C to + 100°C			
Lead Soldering Temperature [2.0mm (.079") From Body]	260°C for 5 Seconds Max.			

### 4. Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Color	Min.	Typ.	Max.	Unit	Test Condition
Radiant Intensity	Iv	Blue Green White	18 110 120	30 180 200	50 310 680	mcd	IF = 8mA Note 1,4
Viewing Angle	2θ1/2	Blue Green White	-	120 120 100	-	deg	Note 2 (Fig.6)
Chromaticity Coordinates	x	White	-	0.24	-	nm	IF = 8mA, Note 5 Hue Spec. Table & Chromaticity Diagram
	y		-	0.2	-	nm	
Dominant Wavelength	λd	Blue Green	460 520	465 525	470 530	nm	Note 3
Forward Voltage	VF	Blue Green White	2.5 2.5 2.4	2.8 2.8 2.8	3.3 3.3 3.2	V	IF = 8mA
Reverse Current	IR	Blue Green White	-	-	10	μA	VR = 5V, Note 6

#### NOTE:

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- θ1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- Iv guarantee must be included with ±15% testing tolerance.
- The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.
- Reverse voltage (VR) condition is applied for IR test only. The device is not designed for reverse operation.

# Through Hole Lamp LTW-404M01H279

## 5. Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

Blue

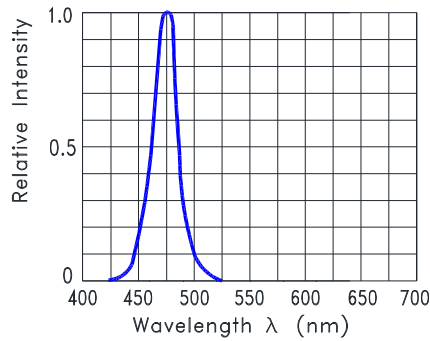


Fig.1 Relative Intensity VS. Wavelength

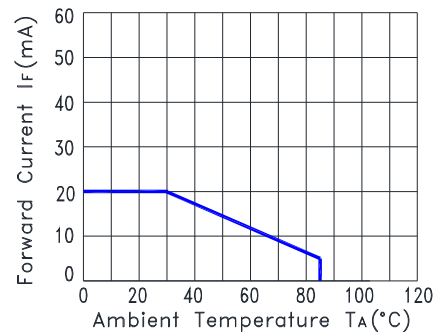


Fig.2 Forward Current Derating Curve

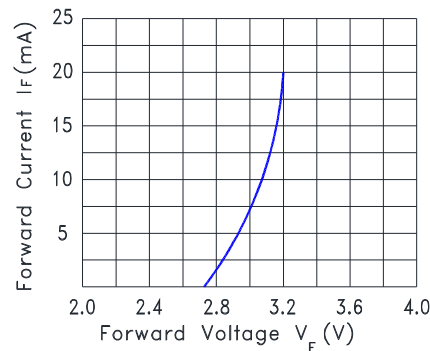


Fig.3 Forward Current vs. Forward Voltage

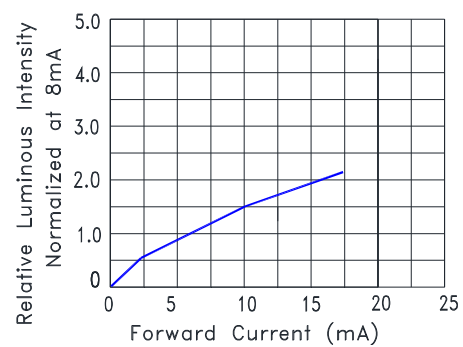


Fig.4 Relative Luminous Intensity vs. Forward Current

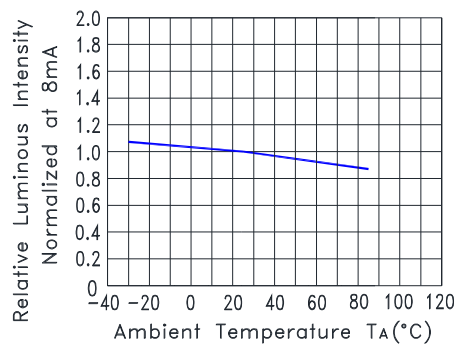


Fig.5 Relative Luminous Intensity VS. Ambient Temperature

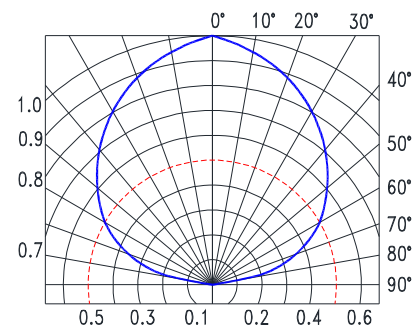


Fig.6 Spatial Distribution

# Through Hole Lamp LTW-404M01H279

Green

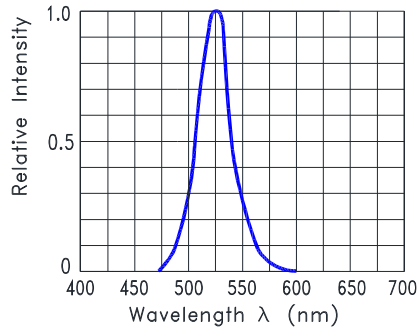


Fig.1 Relative Intensity VS. Wavelength

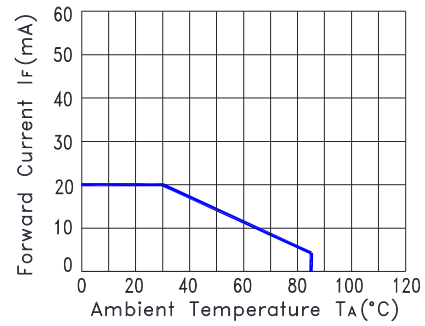


Fig.2 Forward Current Derating Curve

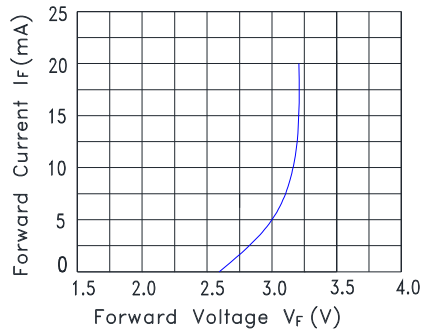


Fig.3 Forward Current vs. Forward Voltage

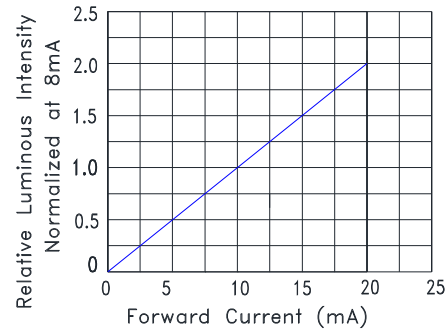


Fig.4 Relative Luminous Intensity vs. Forward Current

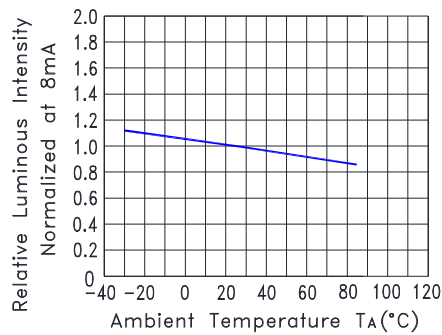


Fig.5 Relative Luminous Intensity VS. Ambient Temperature

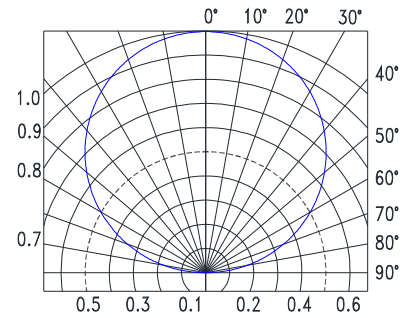


Fig.6 Spatial Distribution

# Through Hole Lamp LTW-404M01H279

White

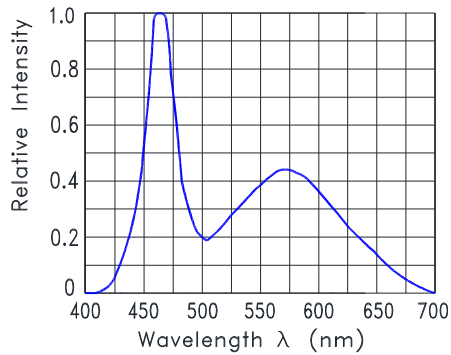


Fig.1 Relative Intensity VS. Wavelength

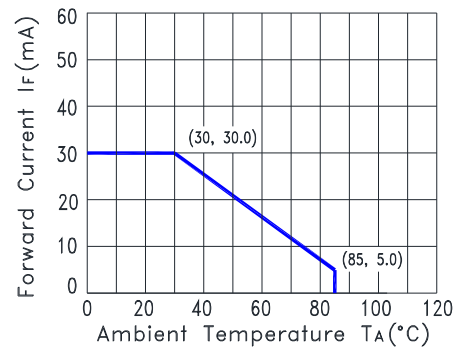


Fig.2 Forward Current Derating Curve

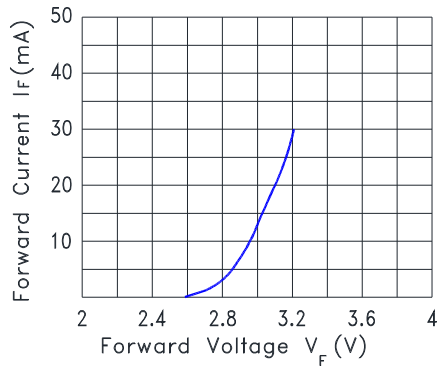


Fig.3 Forward Current vs. Forward Voltage

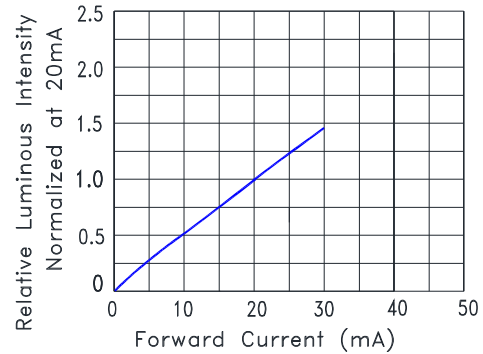


Fig.4 Relative Luminous Intensity vs. Forward Current

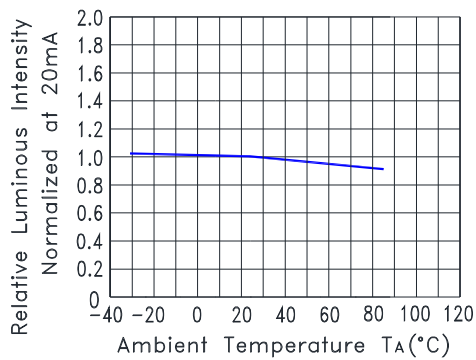


Fig.5 Relative Luminous Intensity VS. Ambient Temperature

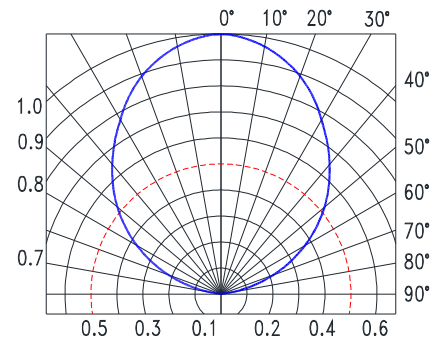
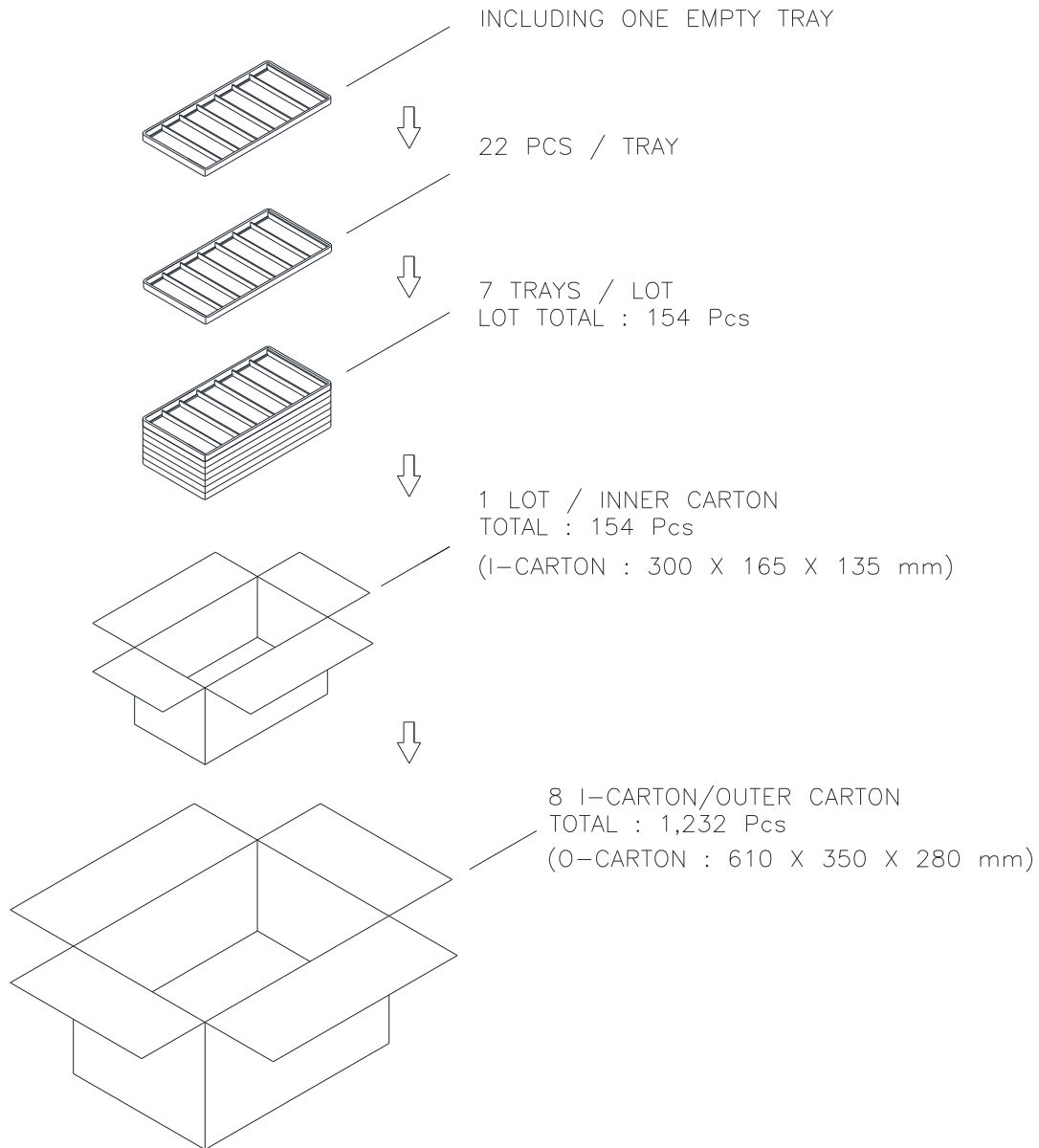


Fig.6 Spatial Distribution

## Through Hole Lamp LTW-404M01H279

### 6. Packing Specification





## Through Hole Lamp LTW-404M01H279

### 7. Bin Table Specification

#### CBI Bin Code for Reference

CBI BIN CODE		
Code 1 (Blue Color)	Code 2 (White Color)	Code 3 (Green Color)
X	X	X

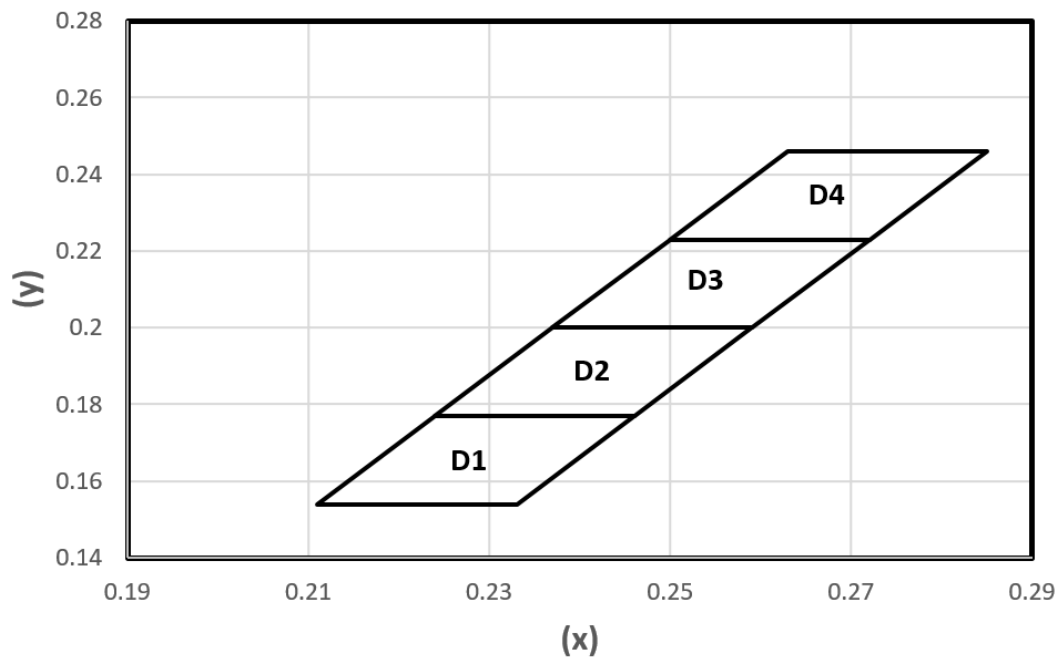
CODE 1 (Blue Color)	Code 1	Lamp Bin Code	Specification (Iv/Hue/Vf)@8mA
	1	3XZ / AB, B07	18~50mcd, 460~465nm, 2.5~3.3V
	2	3XZ / AB, B08	18~50mcd, 465~470nm, 2.5~3.3V
CODE 2 (White Color)	Code 2	Lamp Bin Code	Specification (Iv/CCx,y/Vf)@8mA
	1	GH / JK / LM, D1	120~680mcd, D1, 2.4~3.2V
	2	GH / JK / LM, D2	120~680mcd, D2, 2.4~3.2V
	3	GH / JK / LM, D3	120~680mcd, D3, 2.4~3.2V
	4	GH / JK / LM, D4	120~680mcd, D4, 2.4~3.2V
CODE 3 (Green Color)	Code 3	Lamp Bin Code	Specification (Iv/Hue)@8mA
	1	FG / HJ, G09	110~310mcd, 520~525nm, 2.5~3.3V
	2	FG / HJ, G10	110~310mcd, 525~530nm, 2.5~3.3V

Note: Tolerance of each bin limit is  $\pm 15\%$ , Color Coordinates Measurement allowance is  $\pm 0.01$

# Through Hole Lamp LTW-404M01H279

C.I.E. 1931 Chromaticity Diagram

Hue Ranks	Chromaticity Coordinates CC(x, y), IF@8mA				
D1	x	0.211	0.224	0.246	0.233
	y	0.154	0.177	0.177	0.154
D2	x	0.224	0.237	0.259	0.246
	y	0.177	0.200	0.200	0.177
D3	x	0.237	0.250	0.272	0.259
	y	0.200	0.223	0.223	0.200
D4	x	0.250	0.263	0.285	0.272
	y	0.223	0.246	0.246	0.223



## Through Hole Lamp LTW-404M01H279

### 8. CAUTIONS

#### 8.1. Application

This LED lamp is good for application of indoor and outdoor sign, also ordinary electronic equipment.

#### 8.2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

#### 8.3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

#### 8.4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming. Lead forming must be done before soldering, at normal temperature. During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

#### 8.5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided. Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

#### Recommended soldering conditions:

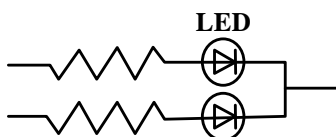
Soldering iron		Wave soldering	
Temperature	350°C Max.	Pre-heat	120°C Max.
Soldering time	3 seconds Max. (one time only)	Pre-heat time	100 seconds Max.
Position	No closer than 2mm from the base of the epoxy bulb	Solder wave	260°C Max.
		Soldering time	5 seconds Max.
		Dipping Position	No lower than 2mm from the base of the epoxy bulb

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through-hole type LED lamp product. Max temperature of wave soldering is not means that Holder's HDT/Melting temperature.

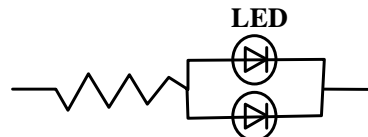
#### 8.6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model (A)



Circuit model (B)



(A) Recommended circuit

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

## Through Hole Lamp LTW-404M01H279

### 8.7. ESD (Electrostatic Discharge)

**Static Electricity or power surge will damage the LED.**

**Suggestions to prevent ESD damage:**

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

**Suggested checking list:**

#### Training and Certification

- 8.7.1.1. Everyone working in a static-safe area is ESD-certified?
- 8.7.1.2. Training records kept and re-certification dates monitored?

#### Static-Safe Workstation & Work Areas

- 8.7.2.1. Static-safe workstation or work-areas have ESD signs?
- 8.7.2.2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 8.7.2.3. All ionizer activated, positioned towards the units?
- 8.7.2.4. Each work surface mats grounding is good?

#### Personnel Grounding

- 8.7.3.1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
  - 8.7.3.1. If conductive footwear used, conductive flooring also present where operator stand or walk?
  - 8.7.3.2. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
  - 8.7.3.3. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
  - 8.7.3.4. All wrist strap or heel strap checkers calibration up to date?
- Note: \*50V for Blue LED.

#### Device Handling

- 8.7.4.1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 8.7.4.2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 8.7.4.3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 8.7.4.4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

#### Others

- 8.7.5.1. Audit result reported to entity ESD control coordinator?
- 8.7.5.2. Corrective action from previous audits completed?
- 8.7.5.3. Are audit records complete and on file?

## Through Hole Lamp LTW-404M01H279

### 9. Reliability Test

Classification	Test Item	Test Condition	Sample Size	Reference Standard
Endurance Test	Operation Life	Ta = Under room temperature IF = per datasheet maximum drive current Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1026 (1995) MIL-STD-883G:1005 (2006)
	High Temperature High Humidity storage	Ta = 60°C RH = 90% Test Time= 240hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-202G:103B (2002) JEITA ED-4701:100 103 (2001)
	High Temperature Storage	Ta= 105 ± 5°C Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1031 (1995) MIL-STD-883G:1008 (2006) JEITA ED-4701:200 201 (2001)
	Low Temperature Storage	Ta= -55 ± 5°C Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	JEITA ED-4701:200 202 (2001)
Environmental Test	Temperature Cycling	100°C ~ 25°C ~ -40°C ~ 25°C 30mins 5mins 30mins 5mins 30 Cycles	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1051 (1995) MIL-STD-883G:1010 (2006) JEITA ED-4701:100 105 (2001) JESD22-A104C (2005)
	Thermal Shock	100 ± 5°C ~ -30°C ± 5°C 15mins 15mins 30 Cycles (<20 secs transfer)	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1056 (1995) MIL-STD-883G:1011 (2006) MIL-STD-202G:107G (2002) JESD22-A106B (2004)
	Solder Resistance	T.sol = 260 ± 5°C Dwell Time= 10±1 seconds 3mm from the base of the epoxy bulb	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2031(1995) JEITA ED-4701: 300 302 (2001)
	Solderability	T. sol = 245 ± 5°C Dwell Time= 5 ± 0.5 seconds (Lead Free Solder, Coverage ≥ 95% of the dipped surface)	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2026 (1995) MIL-STD-883G:2003 (2006) MIL-STD-202G:208H (2002) IPC/EIA J-STD-002 (2004)
	Soldering Iron	T. sol = 350 ± 5°C Dwell Time= 3.5 ± 0.5 seconds	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-202G:208H (2002) JEITA ED-4701:300 302 (2001)

### 10. Others

White LED is materialized by combining blue LED and phosphors. Color of White LED is changed a little by an operating current.

The appearance and specifications of the product may be modified for improvement, without prior notice.